$\begin{smallmatrix} \mathsf{P} & \mathsf{C} & \mathsf{B} \\ \end{smallmatrix} \quad \mathsf{L} \; \mathsf{A} \; \mathsf{Y} \; \mathsf{O} \; \mathsf{U} \; \mathsf{T} \quad \mathsf{D} \; \mathsf{O} \; \mathsf{C} \; \mathsf{U} \; \mathsf{M} \; \mathsf{E} \; \mathsf{N} \; \mathsf{T} \; \mathsf{A} \; \mathsf{T} \; \mathsf{I} \; \mathsf{O} \; \mathsf{N} \\ \end{smallmatrix}$

DK-Audio A/S - PT5201

P/N : 4008 117 08012

Document Number : 4008 117 08012.PCB

Document Issue : 2

Date of Issue : 2002.12.02

Prepared by : GHDsign Aps

Distributed to :

Approved by

HW engineering : Gunner Bækgaard

Quality Assurance :

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REVISION RECORD

Revision	Date	Authorization of change	Pages affected	Brief description of change
1	2002.09.20		All	Original issue of document.
2	2002.12.02		All	Small changes to circuit.

1 INTRODUCTION

1.1 Scope

This document and the files provided with it, contains all data and specifications necessary for ordering and producing the printed circuit board for:

PT5201

Revision 2 - DK-Audio A/S P/N 4008 117 08012

1.2 Audience and Prerequisites

This document is directed to technical personnel involved in development, production and maintenance of:

PT5201

Revision 2 - DK-Audio A/S P/N 4008 117 08012

1.3 Organization of document

Chapter 1 - is this introduction.

Chapter 2 - presents PCB specifications.

Chapter 3 - presents the drilling and milling information.

Chapter 4 - presents the gerber data.

2002.12.02

2 PCB SPECIFICATIONS

2.1 Quality

The PCBs must be produced in accordance with this document. Topics not covered or only partly covered by this document must be produced in accordance with:

Danish PERFAG 3C

and

UL 94-V0 flammability compliance.

The PCB manufacturers logo, Week/Year code for PCB production, and the UL flammability rating MUST be indicated on the PCB. If the code and rating are only to be placed in specified boxes, it will be specified in clear text on the relevant films. Then no other manufacturer additions on any of the films are allowed. Otherwise it is determined by the manufacturer where to put code and rating. See chapter 2.9 for possible restrictions.

Prior to delivery of multi-layer PCB, a 100% electrical test must be performed.

2.2 Incoming Inspection Level

AQL = 0.65 (Major failures) AQL = 1.00 (Minor failures)

2.3

Multilayer Plated-Through PCB

Number of copper lays

Nominal thickness : 1.6mm

Tolerance of thickness : 10%

Laminate : please refer to section 2.4

Copper thickness : please refer to section 2.4

Blind/buried vias : None.

Minimum track width : 5mil

Minimum clearance : 5mil

Minimum annular ring : 8mil

 ${\tt Impedance-controlled}$

: Yes - on layer 1 , 5 and 6tracks

All measures are final.

Protective coating : minimum $0.05\mu m$ chemical immersion gold and $3-8\mu m$ nickel.

PCB size approximately : 375.0 mm x 177.6 mm

The PCB is intended for Surface Mounted Technology

2.4 PCB Build-Up

La	yer	Material	Thickness
1		Cu	35um
	XXXXXXXXXXXXXXXXXXXXX	FR4	185um
2		Cu	35um
	XXXXXXXXXXXXXXXXXXXXX	FR4	356um
3		Cu	35um
	XXXXXXXXXXXXXXXXXXXXX	FR4	356um
4		Cu	35um
	XXXXXXXXXXXXXXXXXXXXX	FR4	356um
5		Cu	35um
	XXXXXXXXXXXXXXXXXXXXX	FR4	185um
6		Cu	35um

Total thickness 1.65mm

2.5 Holes

Holes, layer 1 through 6:

```
Plated:
   num: 2 size: 15.8mill =
num: 4350 size: 15.8mill =
   num:
                                  0.4mm
                                  0.4 \text{mm} \text{ TOL} = +0/-0.2 \text{mm}
        16 size: 31.5mill =
   num:
                                  0.8mm
          6 size: 35.4mill =
   num:
                                  0.9mm
        49 size: 39.4mill =
   num:
                                    1mm
          4 size: 47.2mill =
                                  1.2mm
   num:
                     63mill =
          6 size:
                                  1.6mm
   num:
          7 size: 66.9mill =
                                  1.7mm
   num:
   num: 12 size: 78.7mill =
                                   2mm
   num: 10 size: 126mill =
                                  3.2mm
Non plated :
   num: 96 size: 31.5mill =
                                  0.8mm
   num:
          2 size: 59.1mill =
                                  1.5mm
   num:
        14 size:
                      61mill =
                                1.55mm TOL= +/-0.075mm
   num:
          2 size:
                      63mill =
                                  1.6mm
          4 size: 118.1mill =
   num:
                                    3mm
```

Tooling holes : 4

It is IMPORTANT, that the tooling holes are drilled in the first drilling process together with the drilling of the plated holes, if any.

2.6 Gold Plated Contacts

None.

2.7 Notation Mask

Number of masks : 1

Mask type : Determined by PCB manufacturer in accordance

with Danish PERFAG 3C.

Mask color : Contrast to Solder Mask.

2.8 Solder Mask

Number of masks : 2

Mask type : Determined by PCB manufacturer in accordance

with Danish PERFAG 3C.

Mask color : Green.

2.9 Additional Remarks

Any changes in solder mask is prohibited without prior authorization in writing from customer. Via holes without openings in the solder mask are by definition tented. Introduction of openings in mask or changes to the size of existing openings is considered a change and therefore prohibited.

Please contact customer if minor modifications are advisable or imply essential cost savings.

IMPEDANCE CONTROLLED TRACKS NOTE:

Gerber files named ZO_XX_PO.PCB describes layers containing impedance controlled tracks.

FOR SPECIFIC IMPEDANCES See Gerber files section: "G04 Embedded aperture table ***"

Go to lines containing " LzXX-*", where XX is the characteristic impedance, to find D-Code definition for a specific impedance.

E.q.:

"G04 Assign aperture for track shape Lz50-outer *** %ADD16C,0.005900*%"

Note: In this case D16 is the D-code specification referred to later in the Gerber file.

3 DRILLING & MILLING INFORMATION

3.1 Drill Data Format

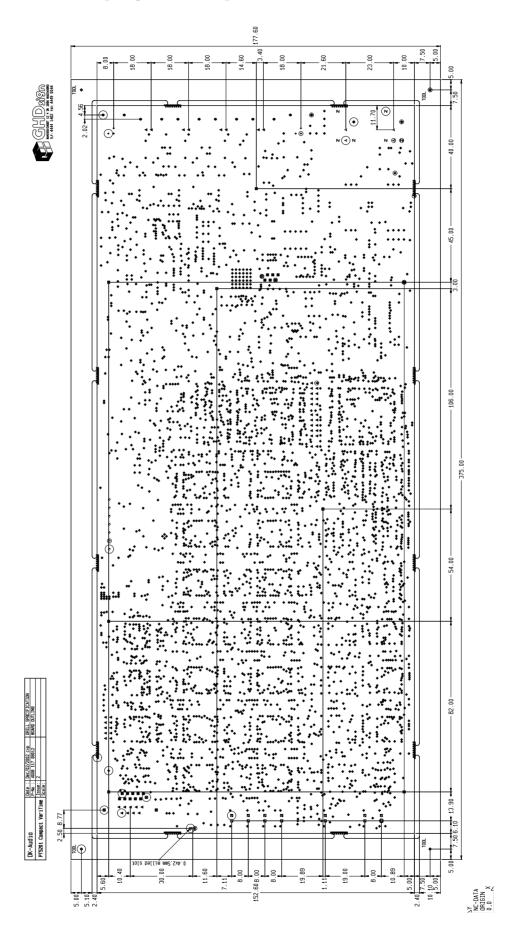
Format of file DRILL.MM

= <32*396>%<13><10> = none = <13><10> start of tape start of block end of block end of tool = none end of plated = M30<13><10><32*396>%<13><10> = none = M30<13><10><32*396><13><10> end of non plated end of tape start of tool change = <13><10>T end of tool change = none header = n supress zeroes = n = n supress equal digits = ascii noparity data code digits before = 3 digits after = 3 data unit = mm autotoolchange = y continuous tool numbering = n

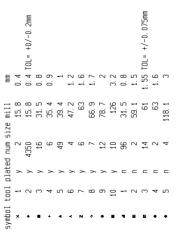
Format of file DRILL.INC

```
start of tape
                         = <32*396>%<13><10>
start of block
                       = none
= <13><10>
end of block
end of tool
                         = none
end of plated
                         = M30<13><10><32*396>%<13><10>
end of non plated
                         = none
end of tape
                         = M30<13><10><32*396><13><10>
start of tool change
                         = <13><10>T
end of tool change
                         = none
header
                         = n
supress zeroes
                         = n
supress zeroes
supress equal digits = n
= ascii noparity
digits before
                        = 2
digits after
                        = 4
data unit
                        = inch
autotoolchange
                        = y
continuous tool numbering = n
```

3.2.1 Drill Drawing Layer 1 through 6 - Scale 0.55



3.2.1.1 Drill Label Layer 1 through 6 - Scale 0.55



4 GERBER DATA

4.1 Gerber Data Format

The gerber files comply with the Extended Gerber Format specification, RS-274X.

4.2 Gerber Files

This chapter presents the gerber files accompanying this document.

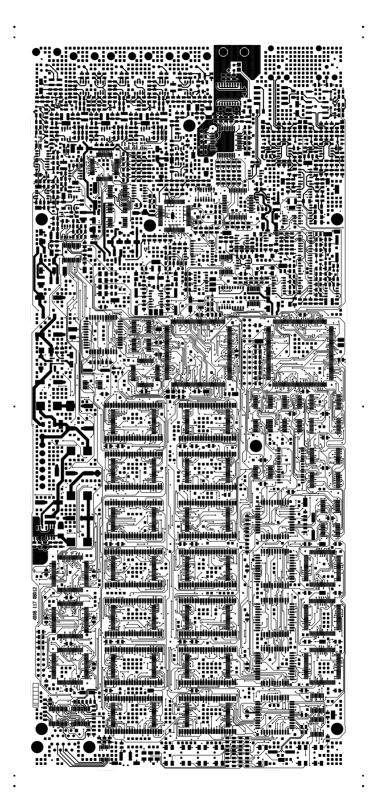
- 1) File name : CU_01_PO.GER
 Electric copper layout for top side.
 Plotted positively in the document.
- 2) File name: CU_02_NE.GER
 Electric copper layout for innerlay 1
 Plotted negatively in the document.
- 3) File name : CU_03_NE.GER Electric copper layout for innerlay 2 Plotted negatively in the document.
- 4) File name: CU_04_NE.GER
 Electric copper layout for innerlay 3
 Plotted negatively in the document.
- 5) File name: CU_05_PO.GER
 Electric copper layout for innerlay 4
 Plotted positively in the document.
- 6) File name : CU_06_PO.GER Electric copper layout for bottom side. Plotted positively in the document.
- 7) File name : SM_01_NE.GER Solder mask layout for top side. Plotted negatively in the document.
- 8) File name: SM_06_NE.GER
 Solder mask layout for bottom side.
 Plotted negatively in the document.
- 9) File name: NO_01_PO.GER
 Component notation layout for top side.
 Plotted positively in the document.
- 10) File name: TM_01_PO.GER
 Tin mask layout for top side.
 Plotted positively in the document.
- 11) File name: FI_01_PO.GER
 Fiducial marks for alignment for top side.
 Plotted positively in the document.
- 12) File name: DR_00_PO.GER
 Drill drawing, common for top and bottom side.
 Plotted positively in the document.

- 13) File name: AS_01_PO.GER
 Assembly drawing for top side.
 Plotted positively in the document.
- 14) File name : Z0_01_PO.GER
 Impedance controlled tracks for top side.
 Plotted positively in the document.
- 15) File name : Z0_05_PO.GER
 Impedance controlled tracks for innerlay 4
 Plotted positively in the document.
- 16) File name: Z0_06_PO.GER
 Impedance controlled tracks for bottom side.
 Plotted positively in the document.

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4.2.1 Layout Drawing - File: CU_01_PO.GER - Scale 0.55

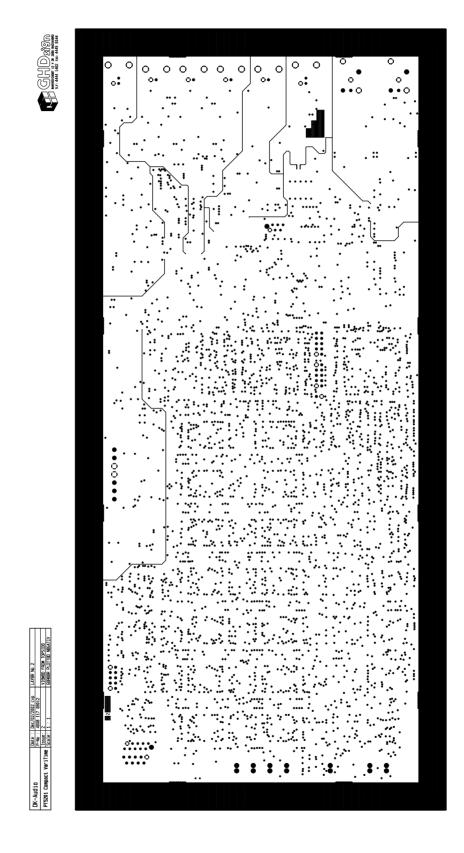






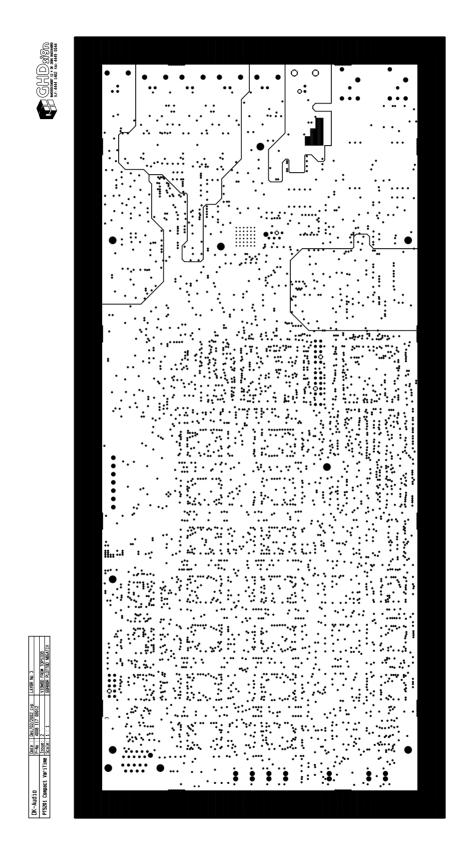


4.2.2 Layout Drawing - File: CU_02_NE.GER - Scale 0.55



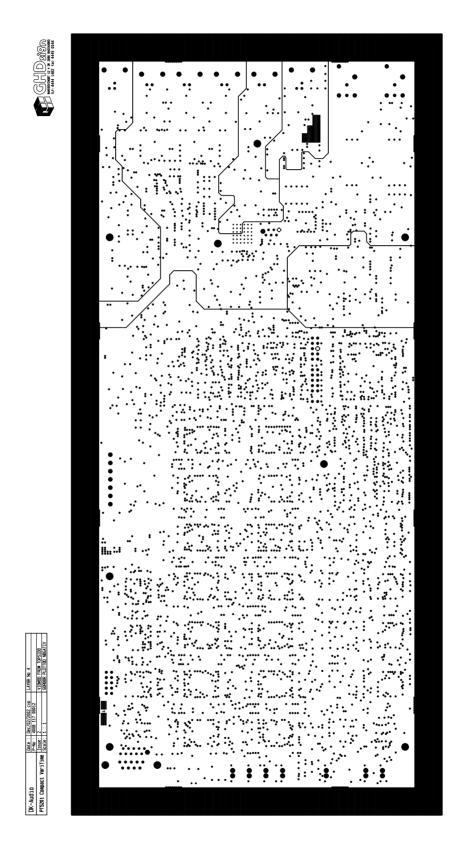


4.2.3 Layout Drawing - File: CU_03_NE.GER - Scale 0.55





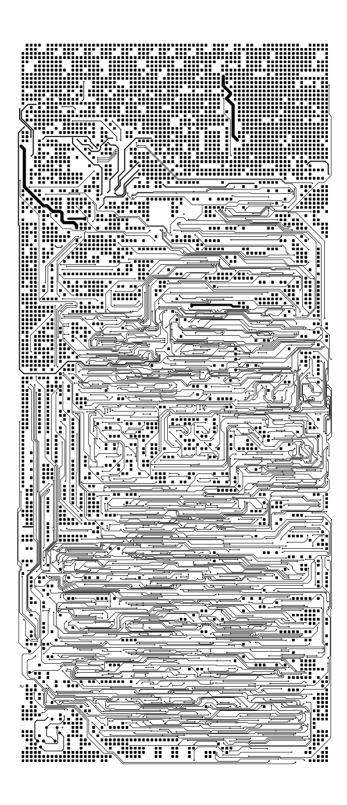
4.2.4 Layout Drawing - File: CU_04_NE.GER - Scale 0.55





4.2.5 Layout Drawing - File: CU_05_PO.GER - Scale 0.55

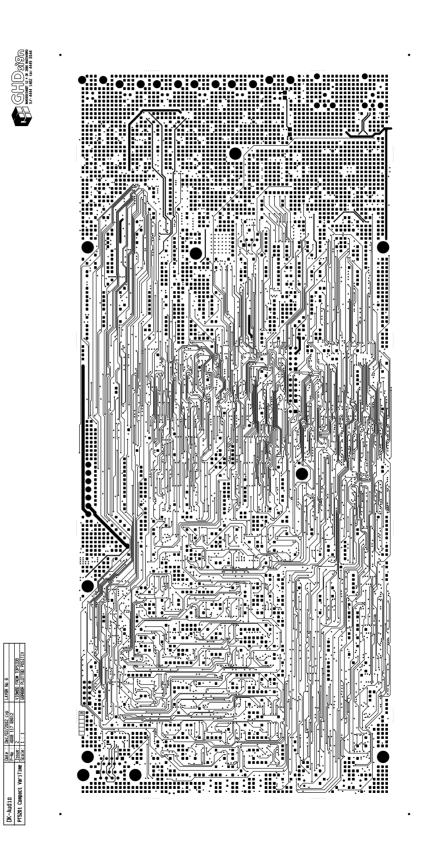








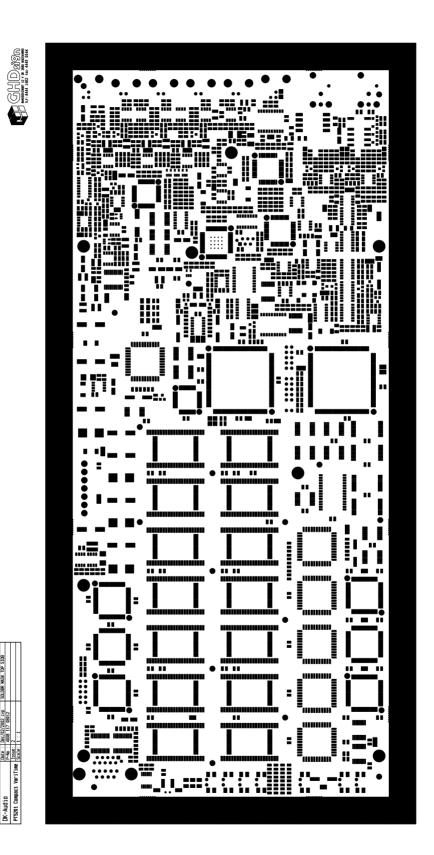
4.2.6 Layout Drawing - File: CU_06_PO.GER - Scale 0.55





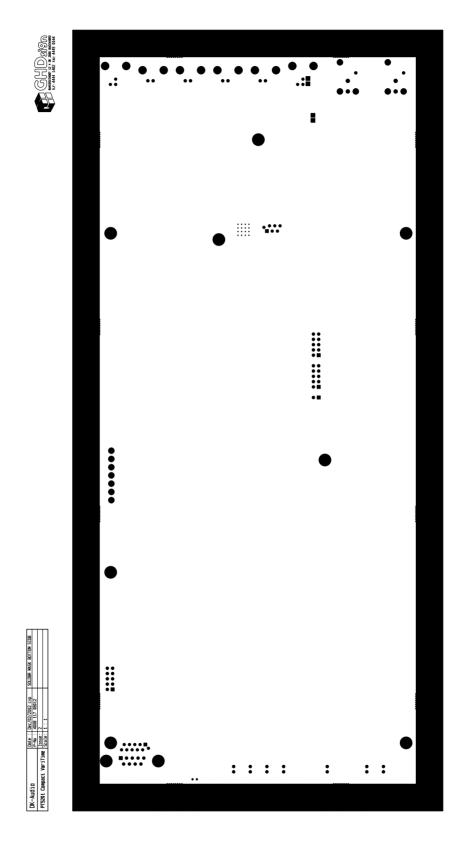
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4.2.7 Layout Drawing - File: SM_01_NE.GER - Scale 0.55



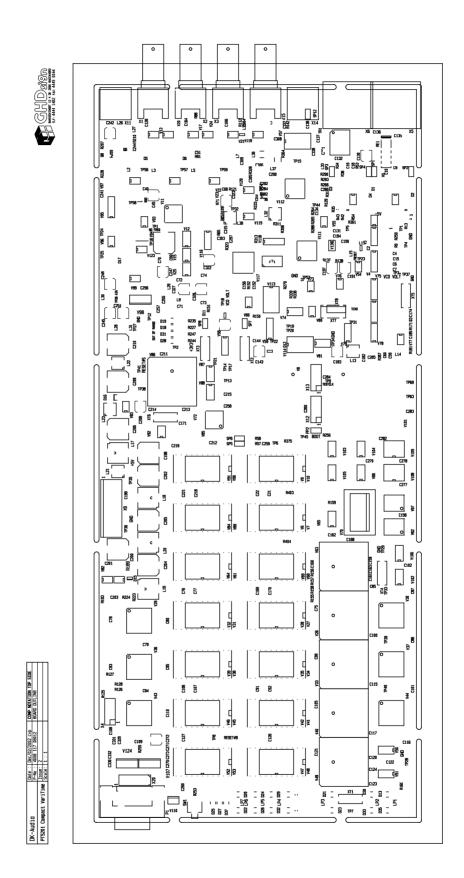


4.2.8 Layout Drawing - File: SM_06_NE.GER - Scale 0.55





4.2.9 Layout Drawing - File: NO_01_PO.GER - Scale 0.55

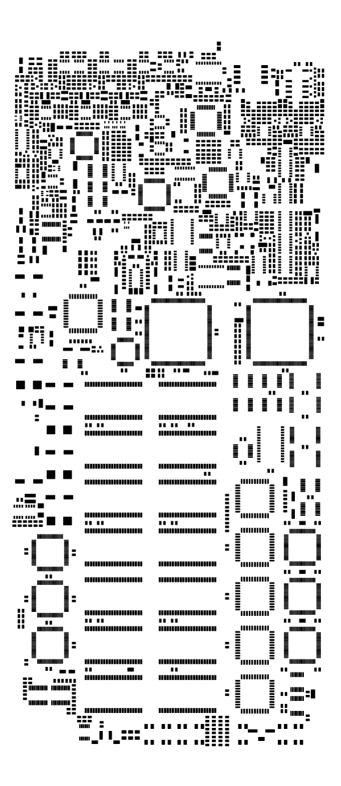


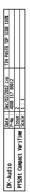


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4.2.10 Layout Drawing - File: TM_01_PO.GER - Scale 0.55

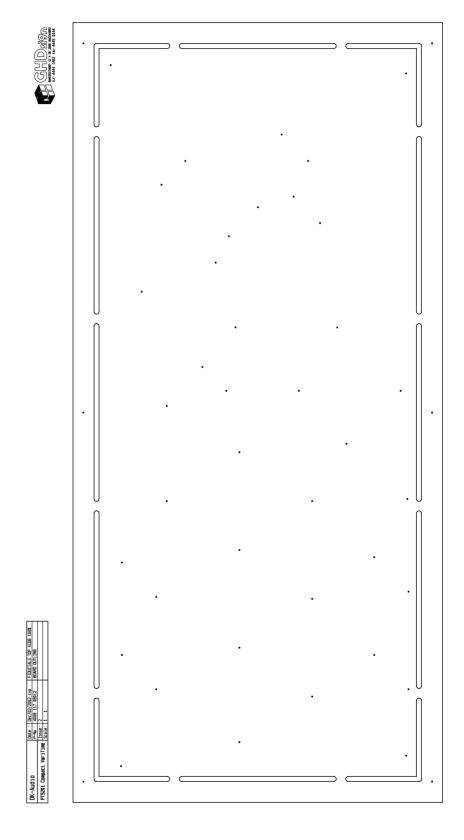






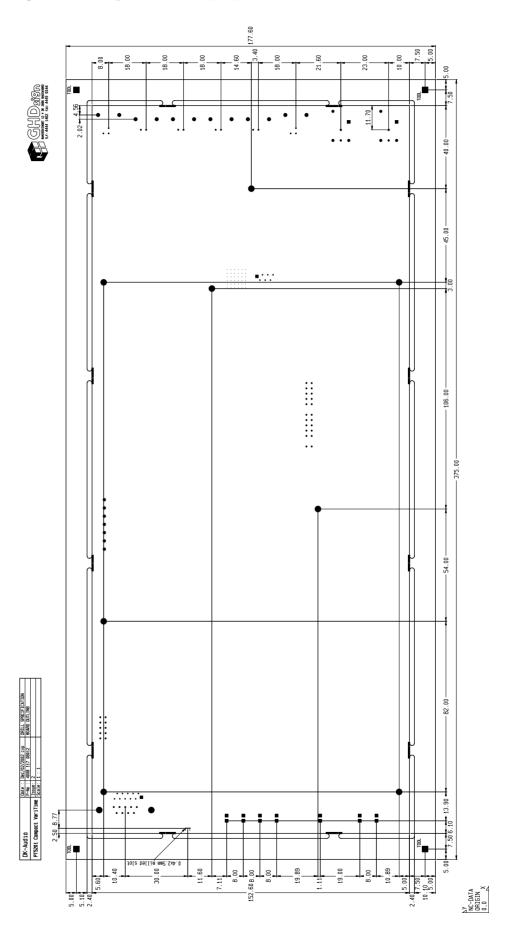


4.2.11 Layout Drawing - File: FI_01_PO.GER - Scale 0.55

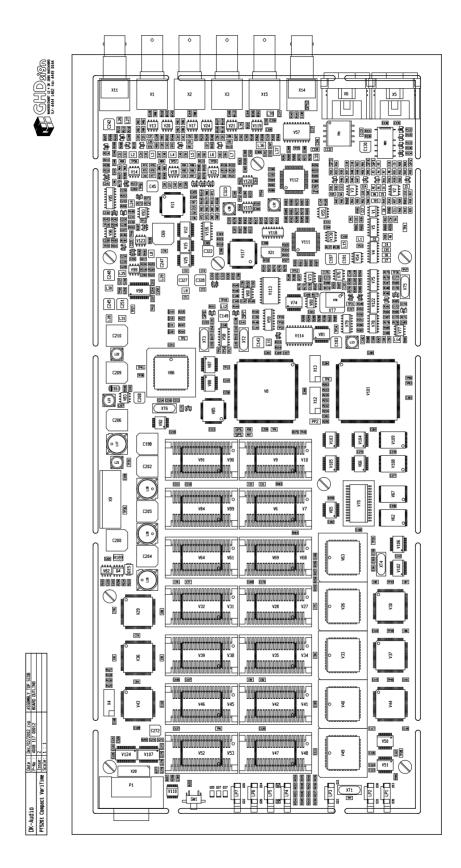




4.2.12 Layout Drawing - File: DR_00_PO.GER - Scale 0.55



4.2.13 Layout Drawing - File: AS_01_PO.GER - Scale 0.55





4.2.14 Layout Drawing - File: Z0_01_PO.GER - Scale 0.55

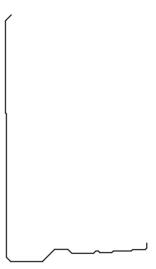






4.2.15 Layout Drawing - File: Z0_05_PO.GER - Scale 0.55









4.2.16 Layout Drawing - File: Z0_06_PO.GER - Scale 0.55







